

CompactPCI[®] Serial

Specification

Short Form Specification

PICMG[®] CPCI-S.0 R1.0, Ratified March 2, 2011

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**Open Modular
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1 Objective

NOTE: Section, Table and Figure numbers in this Short Form Specification are likely to be different from those in the full specification.

1.1 Identification

This specification defines a modular computer system, consisting of

- A backplane
- A system slot
- Up to 24 peripheral boards.

CompactPCI® Serial defines the support of PCI Express, SATA/SAS, USB and Ethernet, concurrently. PCI Express, SATA/SAS and USB are arranged as a simple star architecture. Ethernet is a full mesh. Switch boards are not required and therefore not described.

To support the high-speed serial interfaces a connector is introduced which is compatible with IEEE 1101.

The mechanical design is fully backward compatible to CompactPCI® and will interoperate with existing systems. This specification allows the implementation of hybrid backplanes: CompactPCI® Serial with CompactPCI®, CompactPCI® PlusIO and/or with CompactPCI® Express. 3U and 6U boards are supported with the main focus being on 3U. For 3U a new conductive cooling mechanical concept is introduced which allows to use all boards in a conductive cooled environment as well.

2 General

2.1 Overview

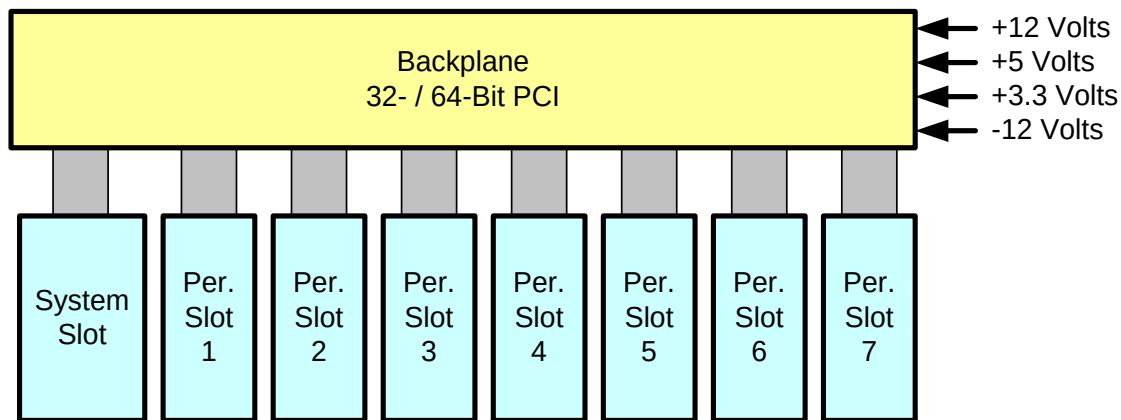
CompactPCI® is a well-established industrial specification for modular computers. The IEEE 1101 compliant mechanics are robust and proven in use. The electrical interface is based on the parallel PCI bus. This technology will successively be replaced by serial, high speed, point-to-point connections.

CompactPCI® Serial uses the mechanical concept of CompactPCI® and uses serial interconnect technology. CompactPCI® Serial does not need special infrastructure hardware. The migration from CompactPCI® to CompactPCI® Serial is made rather simple by using hybrid systems. Even for these, no dedicated switch or bridge boards are required because of specifications like PICMG 2.30.

PICMG 2.30 brings a limited number of serial interconnects to the backplane so that modern peripheral cards can be inserted into legacy CompactPCI® systems. All mechanics are compatible to IEEE 1101.

2.2 CompactPCI® System Architecture

Figure 1 *CompactPCI® System Architecture*



The mechanics of CompactPCI® are fully compliant to IEEE 1101.

Legacy PCI bus architecture is based on parallel buses to connect typical peripheral devices. The parallel bus limits the throughput. Low-performance devices influence and reduce the bandwidth of demanding applications.

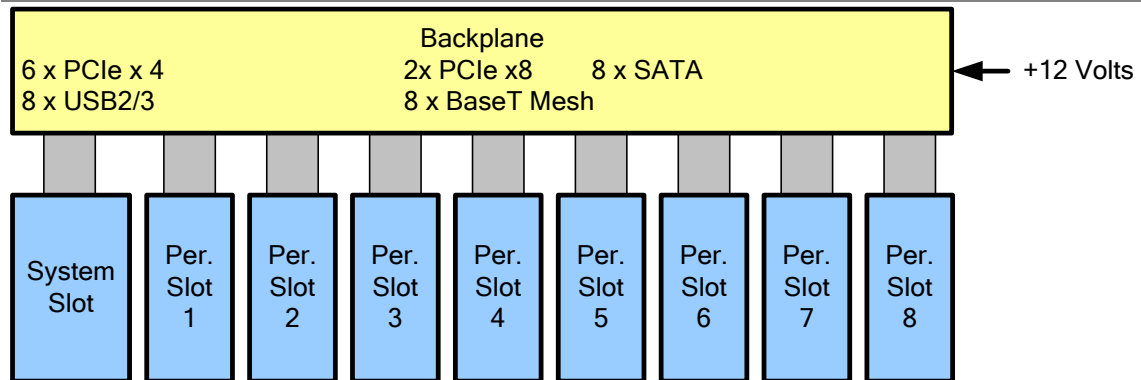
A passive backplane is used to connect a system slot to up to seven peripheral slots. There are several standard backplanes on the market with different numbers of slots. Some of them support rear I/O, some 64-bit operation. The system slot carries some special functions like clock generation or bus arbitration.

Because of those single points of failure, it is common practice for mission critical systems to have two more CompactPCI® backplanes in one 19" rack. Usually Ethernet is used for inter-processor communication.

Four different voltages are defined to supply a CompactPCI® PICMG 2.0 compliant system.

2.3 Architecture Extension by CompactPCI® Serial

Figure 2 **CompactPCI® Serial Architecture**



CompactPCI® Serial uses all the mechanics of CompactPCI®. The specification is compliant to IEEE 1101. Just the 2-mm hard metric connector is replaced by a more modern higher-density connector which is able to support differential signals of 10 Gb/s and even more. Like in CompactPCI® the backplane is fully passive. Supply voltage within a 3U system is 12 Volts only and additional 48 Volts are supplied within a 6U system, which can be used for Power-Over-Ethernet applications.

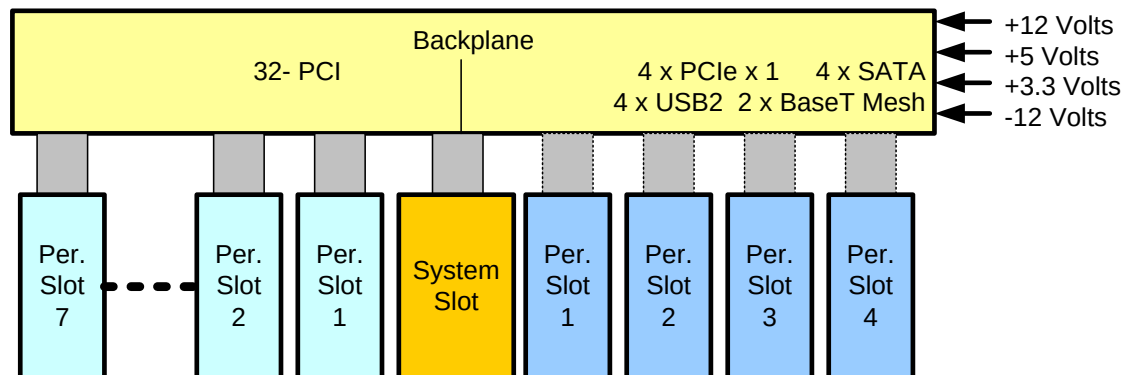
Like in CompactPCI® there is a dedicated system slot which provides the system with some minimal central infrastructure functions like reset and clock supply. This means that the smallest possible CompactPCI® Serial system consists of just one single slot, the system slot. Peripheral slots are connected by modern serial, high speed, point-to-point connections as in MicroTCA, but requiring no switch or hub. Instead, a full star architecture is realized on the backplane for PCI Express, SATA and USB. For Ethernet a full mesh network is implemented on the backplane. A system slot board can be used in a peripheral slot as well to do multiprocessing. The easiest way to communicate in this case is via Ethernet. Ethernet uses cable standards xxBase-T instead of dedicated backplane standards. This lowers the cost, guarantees better interoperability and offers currently up to 10 Gb/s data throughput.

Rear I/O is also supported like in CompactPCI® systems but many more pins are available and higher speed is supported.

CompactPCI® Serial uses the robust mechanics of CompactPCI®, the modern serial interconnects but does not need dedicated infrastructure boards. CompactPCI® Serial is designed for harsh environments and cost-critical applications demanding high throughput and reliability.

2.4 Migration from CompactPCI® to CompactPCI® Serial

Figure 3 **CompactPCI® PlusIO Architecture**



PICMG 2.30, so-called CompactPCI® PlusIO, defines the usage of connector J2 in legacy CompactPCI® systems in a way to bring some of the high speed serial interconnects to the backplane. A CompactPCI® system slot which is compliant to PICMG 2.30 can control up to seven 32-bit legacy CompactPCI® peripheral boards as well as up to four CompactPCI® Serial peripheral boards with limited functionality.

This can easily be realized by means of a hybrid backplane carrying legacy boards as well as CompactPCI® Serial boards because the two specifications, PICMG 2.0 and PICMG CPCI-S.0, are IEEE 1101 compliant.

3 Mechanical Requirements

3.1 General

All dimensions that do not have explicit tolerances within a requirement and/or within technical drawings are for information only. Tolerances of these dimensions are $X.XX \pm 0.10$ mm and $X.X \pm 0.10$ mm.

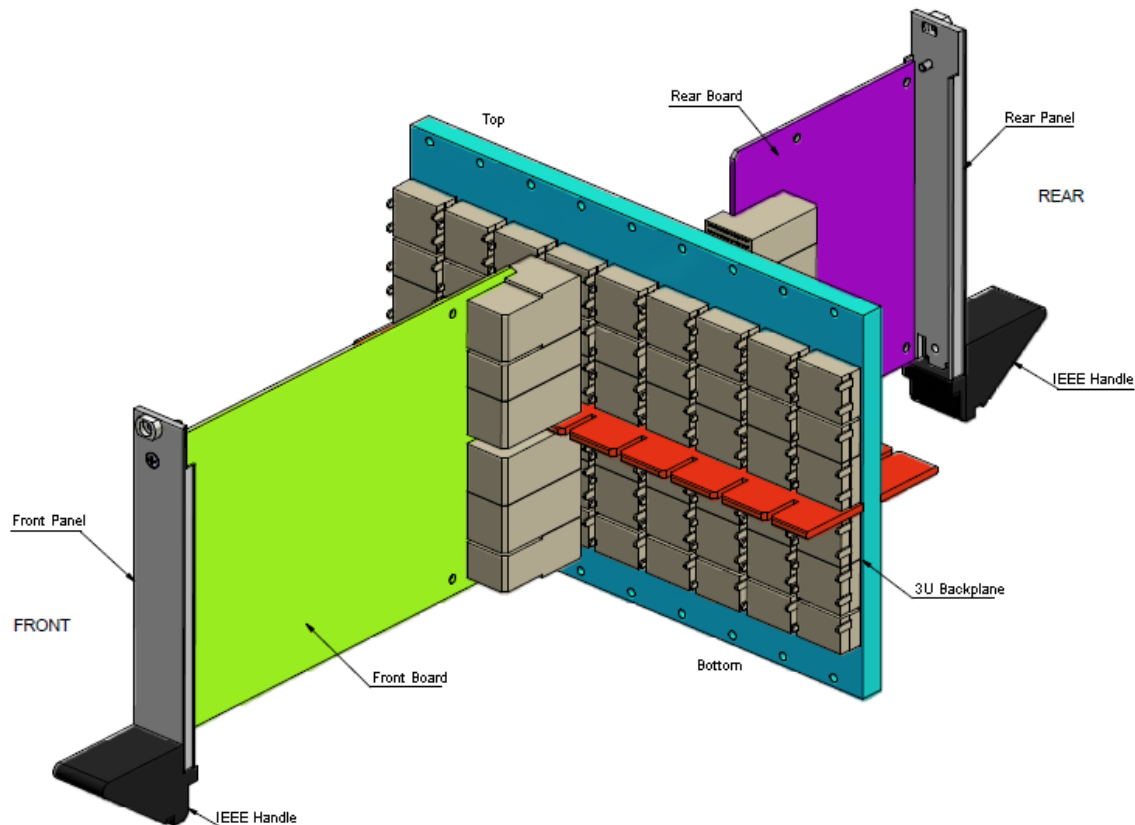
All dimensions that are not explicitly mentioned within a requirement but shown within a technical drawing are recommended only.

3.2 3U Mechanical Overview

A system based on CompactPCI® Serial consists of the same components as a legacy CompactPCI® system. Within this specification 3U systems as well as 6U systems are defined. A passive backplane is used to connect all front and rear boards. Every board is supplied with a front and rear panel. A handle (two handles for 6U) allows the user to plug-in and to remove a board from a rack. A maximum of six discrete connectors forms a slot and the amount of used connectors can vary depending on the application. Thereby maximum scalability and cost-effectiveness is achieved.

Figure 4 shows an example of a nine-slot 3U system. In this example the maximum amount of connectors on the backplane are assembled, to offer maximum connectivity.

Figure 4 *Mechanical Overview 3U Example*



3.3 6U Mechanical Overview

Front and rear boards are defined for the 6U form factor. Compared to a 3U system one extra connector (J0/P0) is defined. This connector offers extra power (that will be needed in a 6U system) and also two further Ethernet connections, which can be used for system management (e.g. AMT).

The backplane can be monolithic or split. Furthermore, it is possible to define a user backplane which is a mixture of both (see Figure 6).

Figure 5 ***Mechanical Overview 6U Example (Split-Backplane / Front view)***

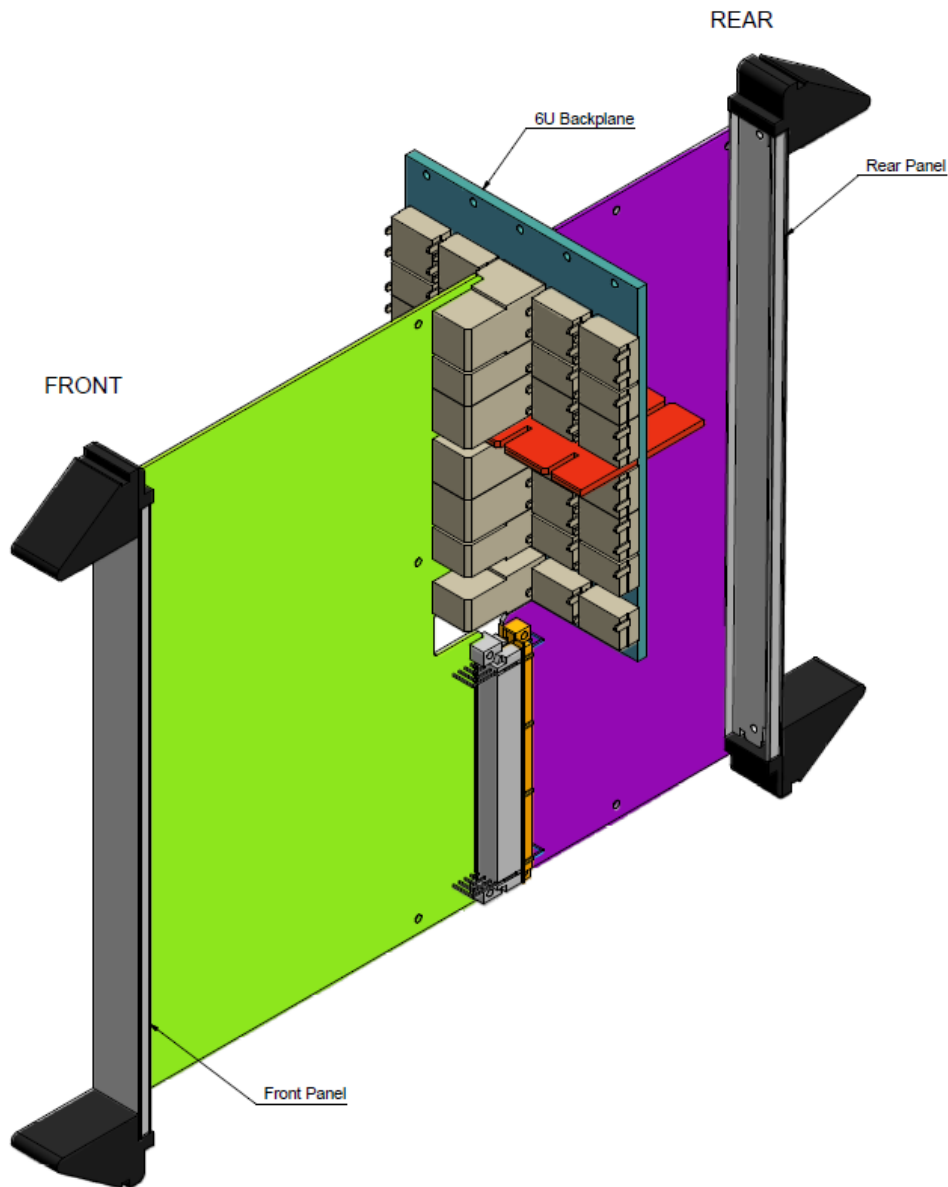
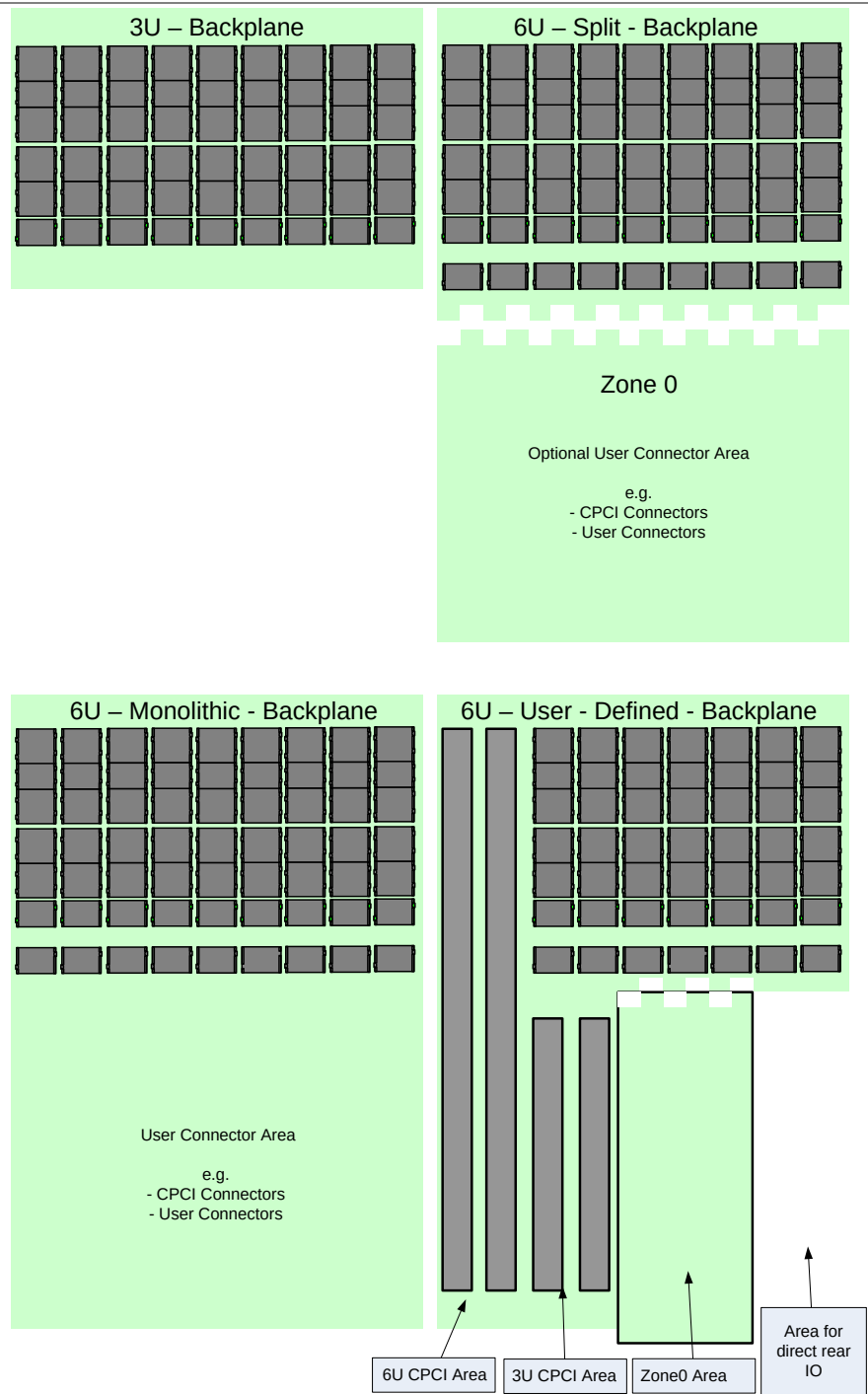


Figure 6 *Backplane Example Drawings of 3U vs. 6U Variants*



Comment: The number of slots as well as the number of connectors is not specified within this specification. This figure is only an example.

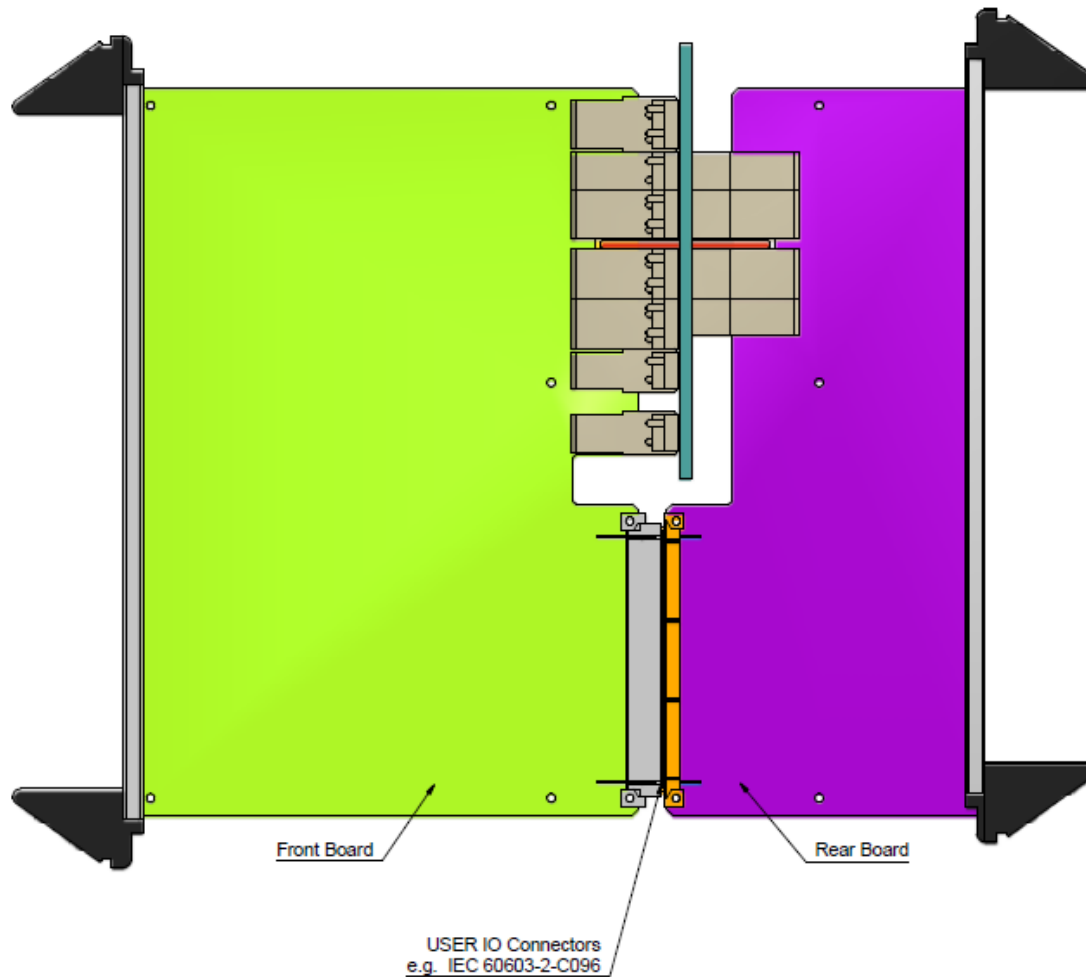
3.3.1 6U Split-Backplane Example

Figure 5 shows an example of a five-slot 6U split-backplane system. In this example also the maximum amount of I/O connectors on the backplane are assembled, to offer maximum

3 Mechanical Requirements

connectivity. Furthermore it is possible to place optional connectors within a “User IO Connector Area”, to connect front and rear board signals. In this case there is a direct user connection without backplane.

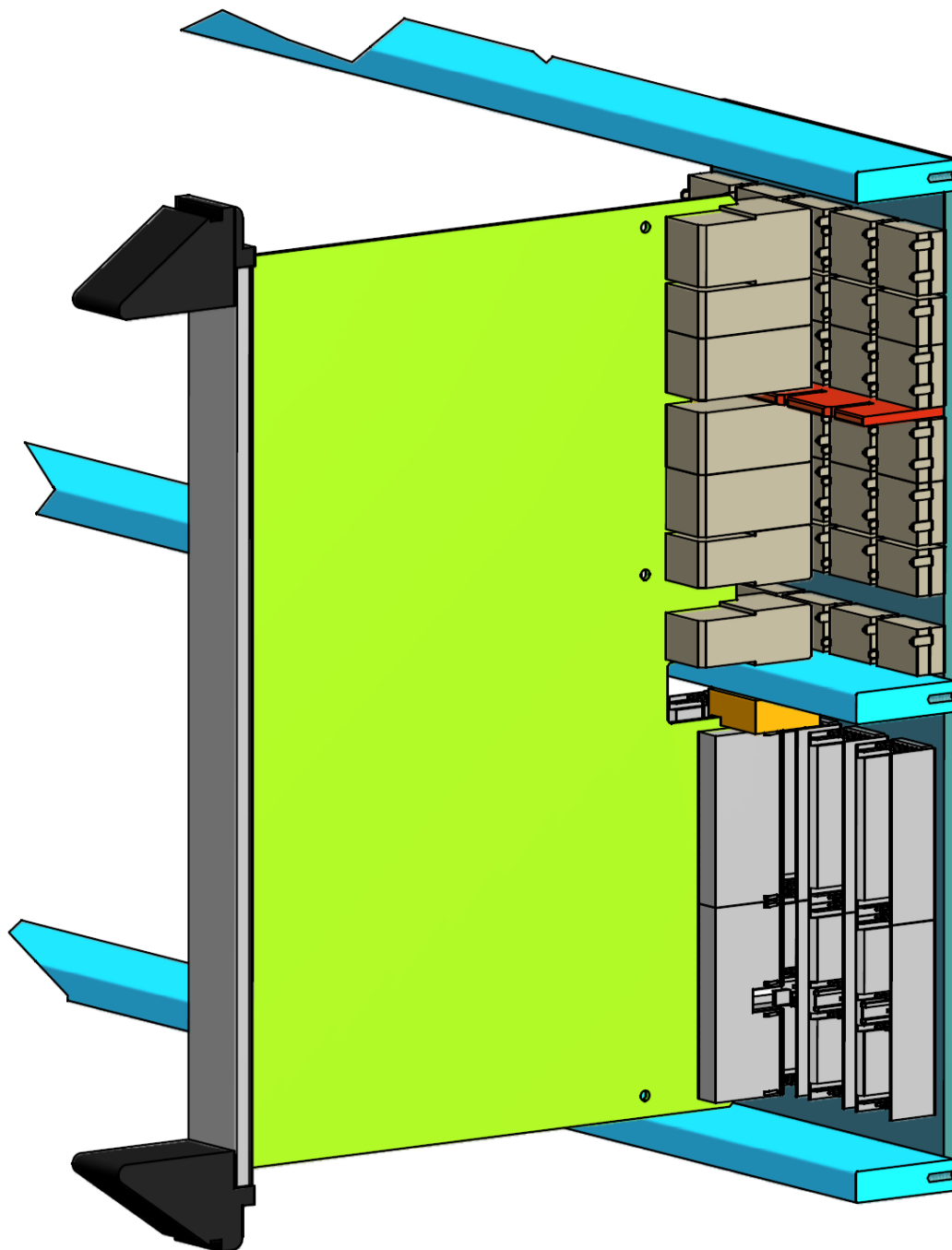
Figure 7 **Mechanical Overview 6U Example (Split-Backplane / Side view)**



3.3.2 6U Monolithic Backplane Example

Figure 8 shows an example of a five-slot 6U monolithic backplane system. In this example also the maximum amount of I/O connectors on the backplane are assembled, to offer maximum connectivity. Furthermore it is possible to place optional connectors within a “User IO Connector Area”, to connect front and rear board signals, or to build a user-defined interconnection between the 6U boards. It is also possible to place CompactPCI® J1/J2 connectors to build up a hybrid system.

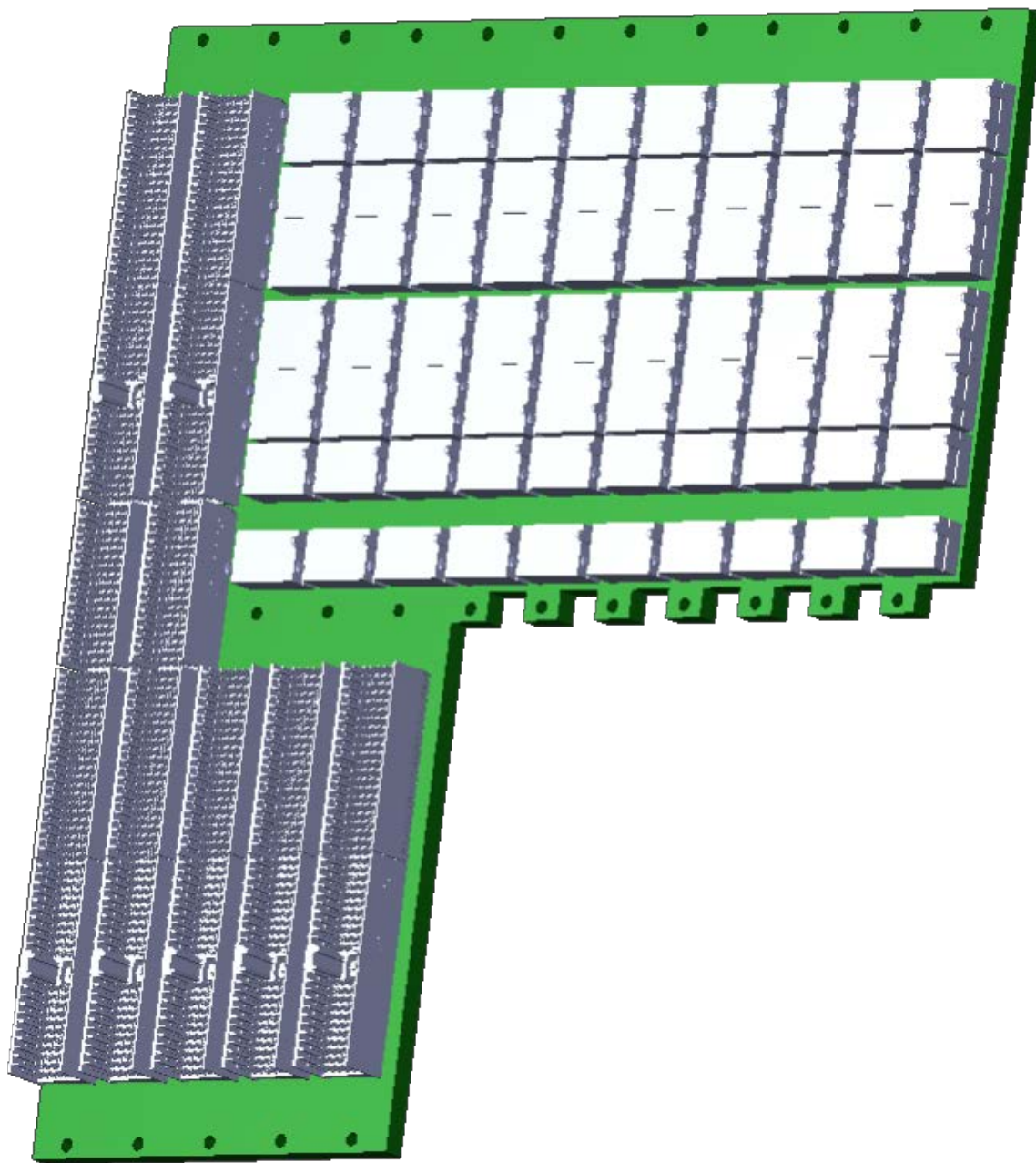
Figure 8 *Mechanical Overview 6U Example (Monolithic Backplane)*



3.3.3 6U User-Defined Backplane Example

It is possible to mix both variants described in chapter 3.3.1 (6U Split-Backplane Example) and chapter 3.3.2 (6U Monolithic Backplane Example). Figure 9 shows such a backplane.

Figure 9 *Mechanical Overview 6U Example (User-Defined Backplane)*



3.4 Connectors

3.4.1 Connector Types and Reference Designation

Connectors used for CompactPCI® Serial are optimized for high-speed differential signal transmission. Shielding and impedance control is maintained through the connectors. The connector is arranged in rows with 12 pins each. 12 pins are sufficient for 4 high speed signal pairs. 4 pins in a row are required for ground. However the pins within the connector are not specialized. So a pin can be used for signals (differential or single ended), for ground, as well as for the supply voltage.

For front boards receptacle connectors are used on the backplane, and right angle headers are used on the plug-in boards. On rear boards it is the converse. All connector types are designed for press-fit mounting. The press-in pin length in the PCB is just 1.6 mm to minimize the stub lengths thereby enhancing the signal integrity. To realize rear I/O, a plug connector is pressed on to the back of the backplane. This mirrors the pin assignment from the front to the back side. There are 10 different types of connector specified.

Table 1 *Connector Types*

Connector Type	Rows	Pins/Row	Type	Location
A	6	12	Plug	Front board
B	8	12	Plug	Front board
C	6	12	Plug	Front board
D	8	12	Plug	Front board
E	6	12	Receptacle	Backplane
F	8	12	Receptacle	Backplane
G	8	12	Receptacle	Rear board
H	6	12	Receptacle	Rear board
I	8	12	Plug	Rear backplane
J	6	12	Plug	Rear backplane

3.4.2 Front Board Connector Types and Reference Designation

To connect the front boards to the backplane, four different plug types of the same connector family are used.

Table 2 *Front Board Connector Types*

Designator	Type	Number of Rows	Number of Walls	Usage
P0	A	6	4	Optional
P1	A	6	4	Mandatory
P2	B	8	2	Optional
P3	B	8	2	Optional

3 Mechanical Requirements

P4	B	8	2	Optional
P5	C	6	2	Optional
P6	D	8	4	Optional

Figure 10 3U Connector Plug Types A, B, C and D on Front Boards

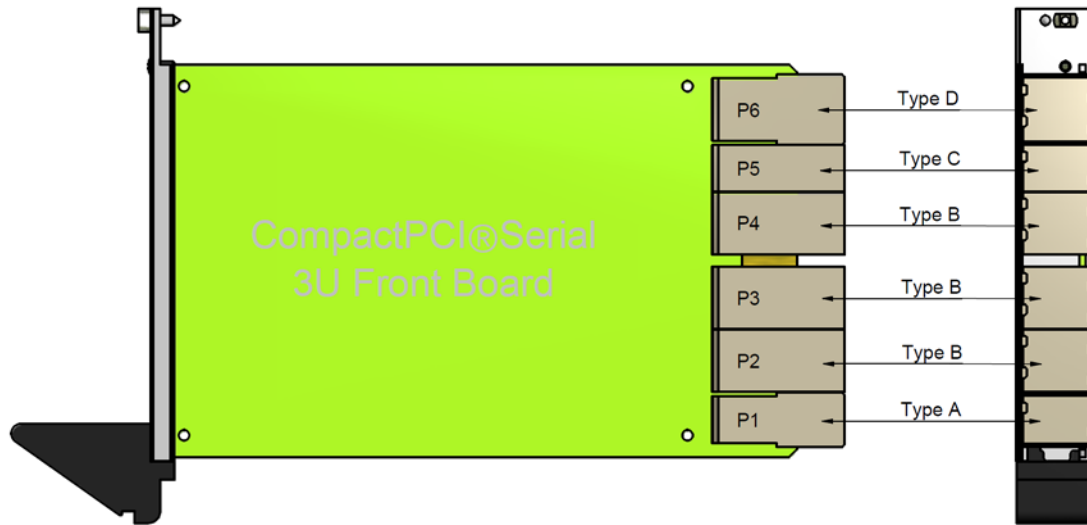
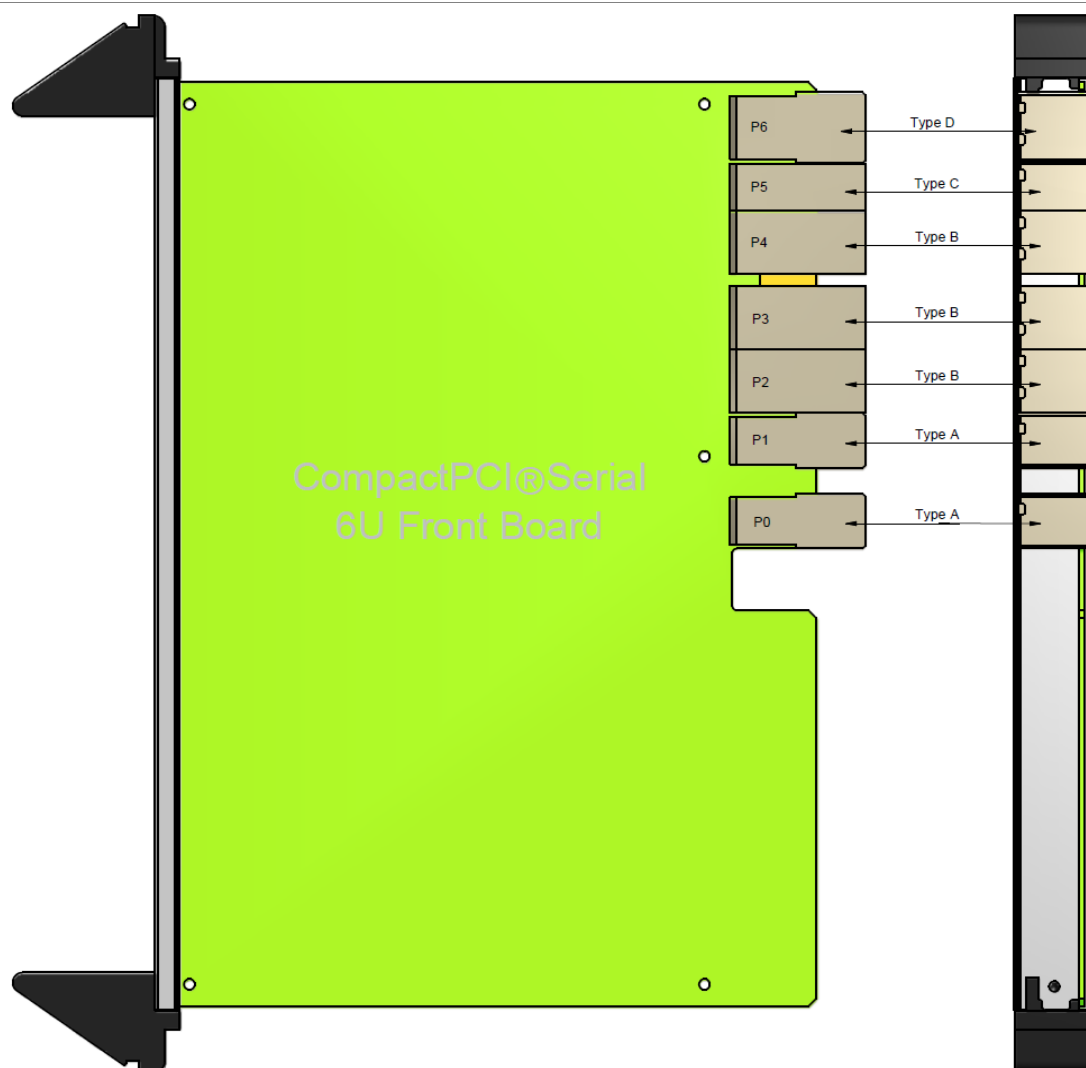


Figure 11 6U Connector Plug Types A, B, C and D on Front Boards



On the backplane there are just 2 different types of receptacles, type E – a six row version and type F – an eight row version. The six row receptacle connects to all type A as well as to type C plugs. The eight row receptacle connects to all type B as well as to type D plugs.

Table 3 Backplane Connector Types

Designator	Type	Number of Rows	Usage
J0	E	6	Optional
J1	E	6	Mandatory
J2	F	8	Optional
J3	F	8	Optional
J4	F	8	Optional
J5	E	6	Optional

3 Mechanical Requirements

J6	F	8	Optional
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3.4.3 Rear Board Connector Types and Reference Designation

To connect the rear boards to the backplane, two different receptacle types of the same connector family are used.

Table 4 *Rear Board Connector Types*

Designator	Type	Number of Rows	Number of Walls	Usage
rJ2	H	6	2	Optional
rJ3	G	8	2	Optional
rJ4	G	8	2	Optional
rJ5	H	6	2	Optional

Figure 12 *Connector Plug Types H and G on Rear Boards*

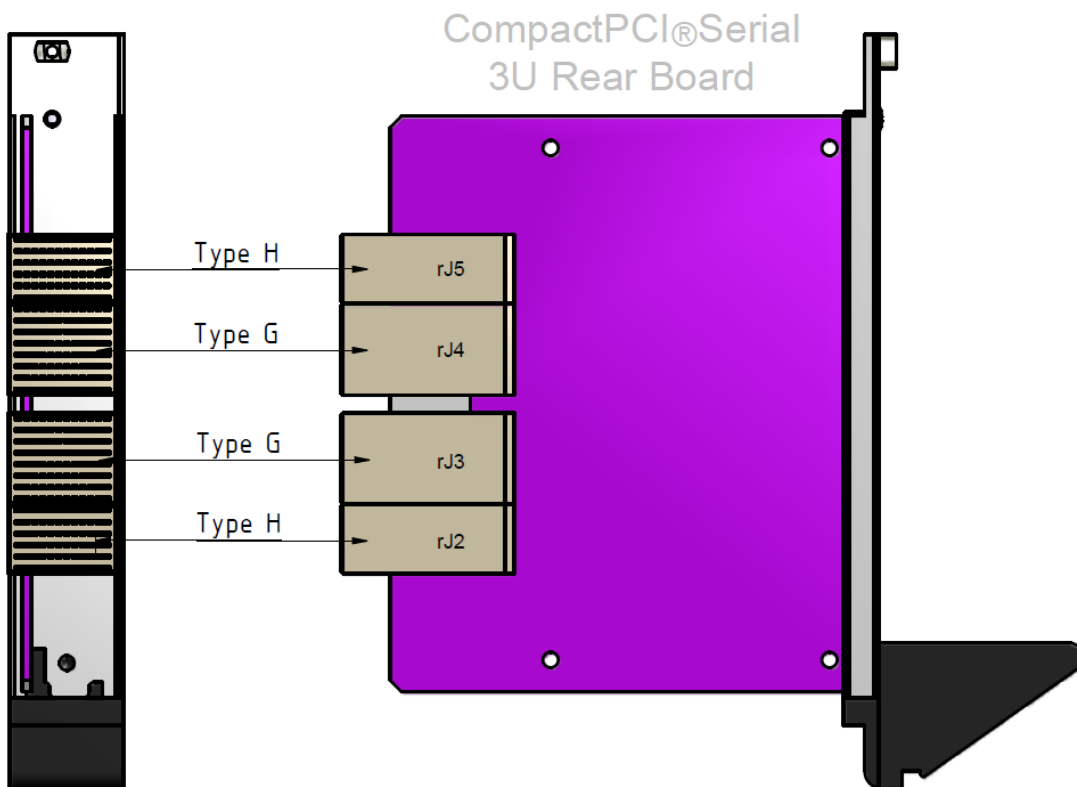


Table 5 *Rear Backplane Connector Types*

Designator	Type	Number of Rows	Usage
rP2	J	6	Optional
rP3	I	8	Optional

rP4	I	8	Optional
rP5	J	6	Optional

3.5 Mezzanine Concept

3.5.1 General

Implementation of the Ethernet connection of a system board can be done with a mezzanine board. Due to this concept more flexibility will be achieved, because the usage of Ethernet does not depend on the system board itself. Furthermore different mezzanine boards can offer a different number of Ethernet connections, thereby obtaining maximum scalability. If this concept is implemented, the CompactPCI® Serial system board becomes a mezzanine host and the mezzanine board can be plugged onto this host. The connector P6 is then placed on the mezzanine board and a cut-out on the mezzanine host is provided. Only the interconnection between the mezzanine host to the CompactPCI® Serial backplane will be specified within this specification. As shown in Figure 13 and Figure 14 the mezzanine concept can be implemented within a 3U and a 6U system.

Figure 13 **3U Mezzanine Concept**

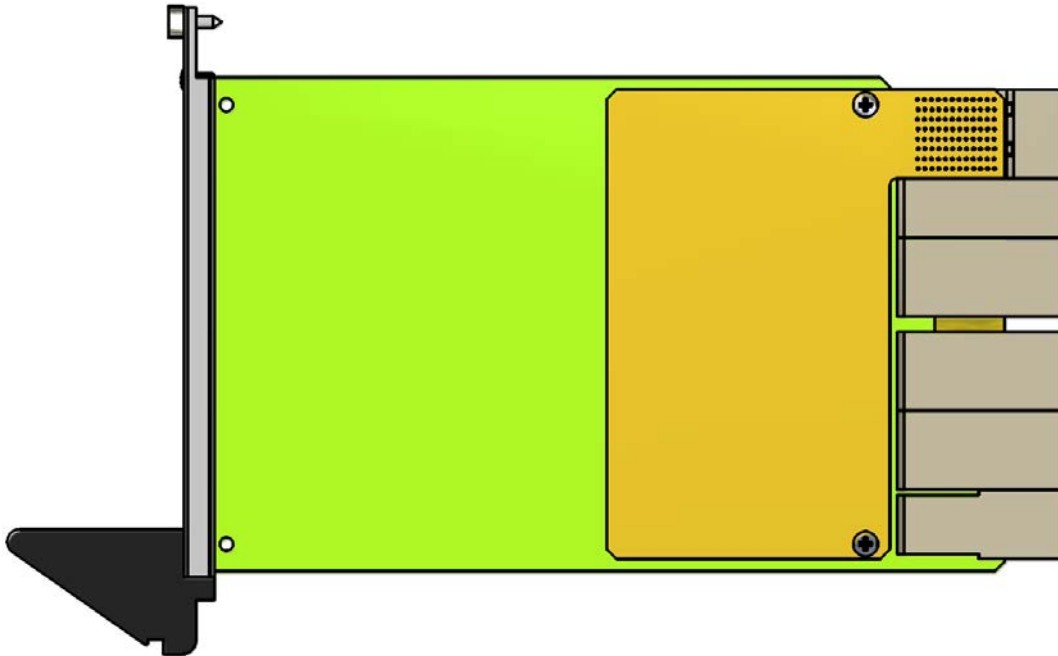
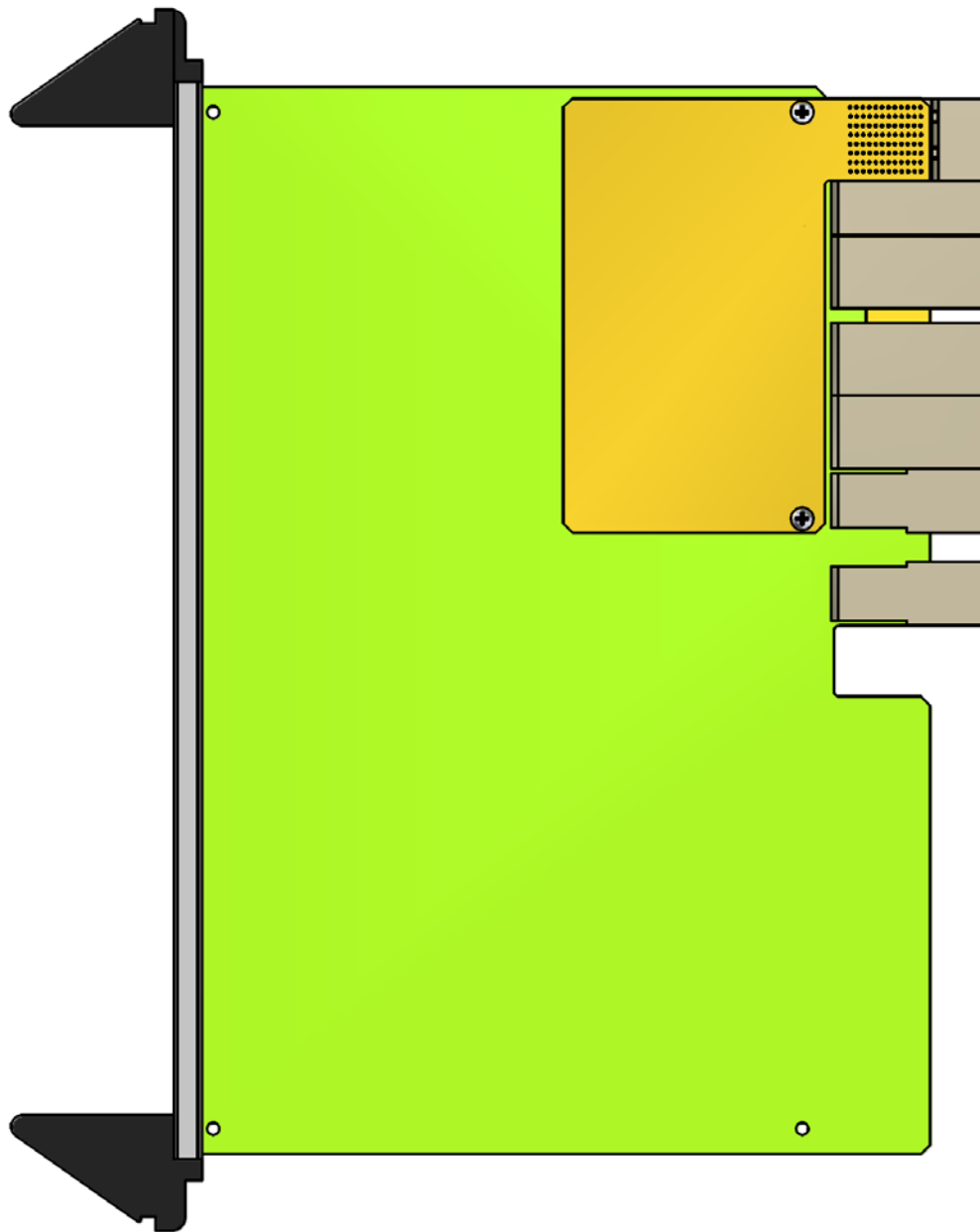
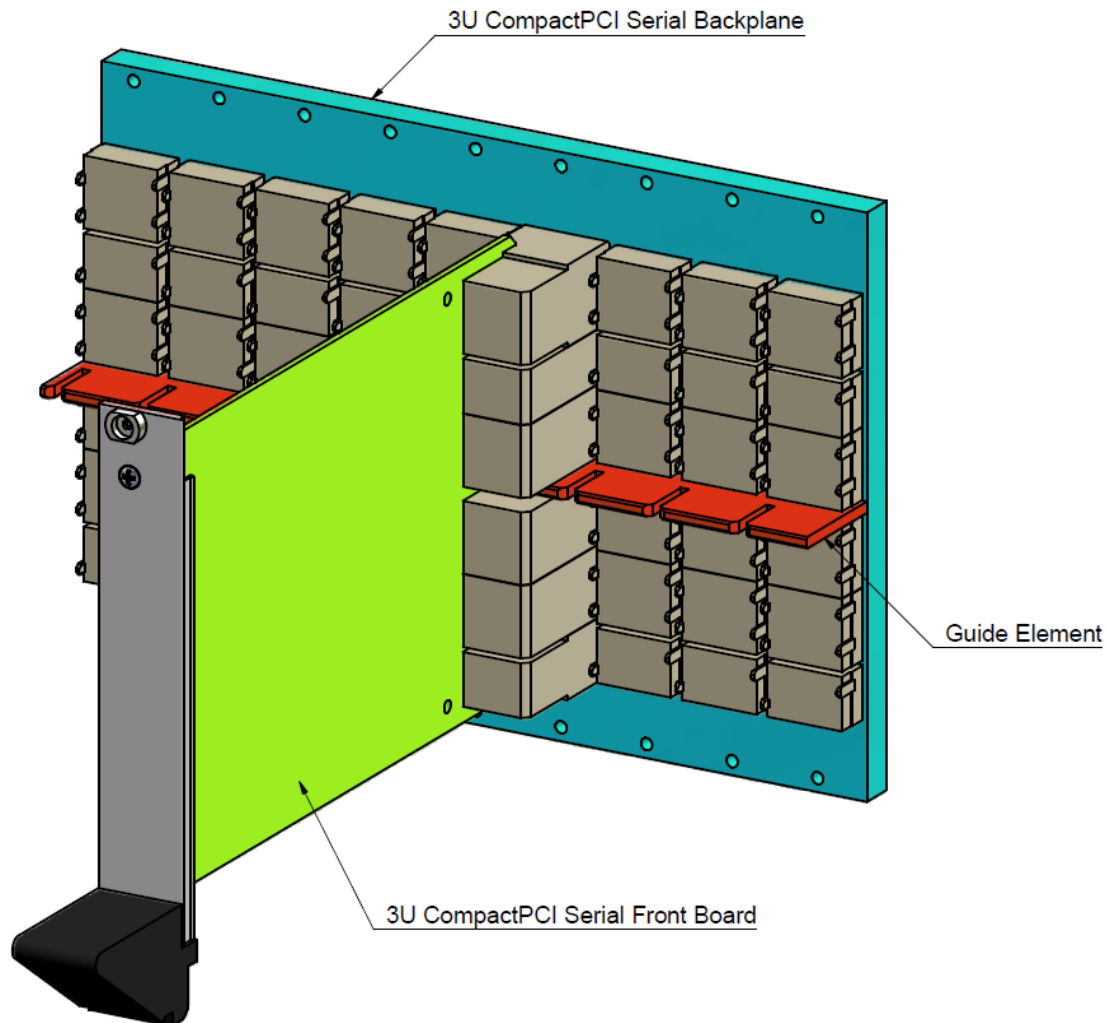


Figure 14 *6U Mezzanine Concept*

3.5.2 Backplane Guide Element

Figure 15 *Guide Element Overview*

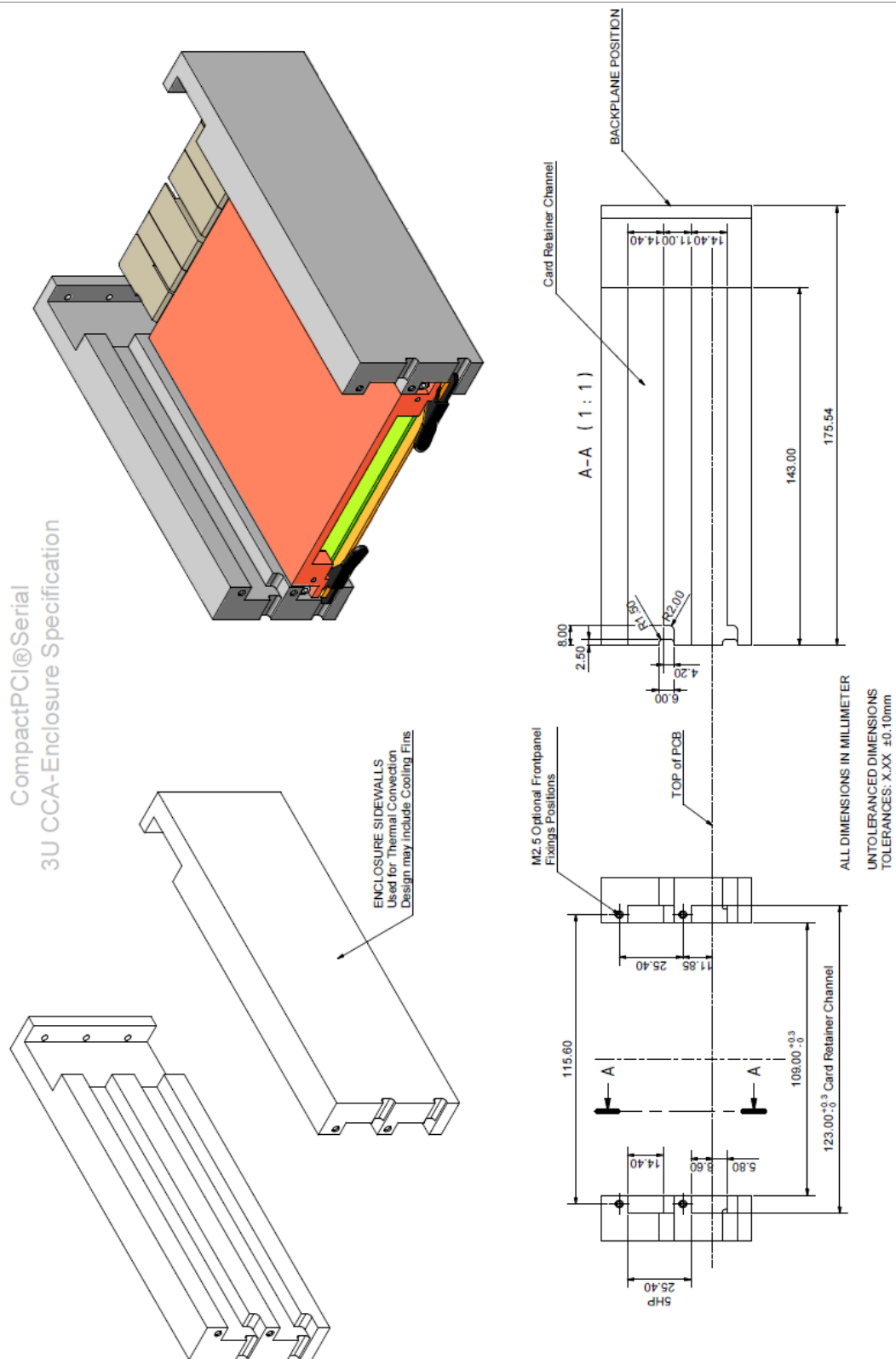


3.5.3 6U Backplane Guidance Rail

To guarantee best fitting of the 6U board connectors into the 6U backplane connectors, also if a board will be plugged in harsh environments, a guidance rail on the backplane is defined.

3 Mechanical Requirements

Figure 17 CCA Enclosure



4 Electrical Requirements

4.1 Power Infrastructure

4.1.1 Backplane Power Distribution

CompactPCI® Serial relies on a single rail +12V main power supply. +5V standby is optionally available. -48V optional voltage is available within a 6U system only. The backplane distributes the supply voltages to the front boards. Rear boards are indirectly supplied by the corresponding front board.

Neither the power supply itself nor the connecting of the power supply to the backplane is a part of this specification. Redundancy concepts for power supplies are also not specified.

Hot-swap is optional and is specified. On the one hand there are requirements for the power supply to handle the peak current as a board is plugged, on the other hand there are requirements for the boards to limit this current. The basic concept utilizes a switch within the handle to signal that a board will be removed. If the board is ready to be drawn-out, an optical signal gives an acknowledgement. Depending on the board an interaction with the hot-plug controller might be required which is located at the system slot.

4.1.2 Geographical Addressing

Comment: Due to the fact that within CPCI-S.0 each physical SATA port always needs the same geographic address (because of SGPIO), geographical addresses do not follow the physical slot numbers, but the SATA filling order.

Table 6 *Physical Slot Addresses*

Physical Slot Number in a 25 Slot System	Physical Slot Number in a 9 Slot System	Physical Slot Number in a 5 Slot System	GA[3]	GA[2]	GA[1]	GA[0]
25	9	5	GND	GND	GND	GND
24	8	4	GND	GND	GND	Open
23	7	3	GND	GND	Open	GND
22	6	2	GND	GND	Open	Open
21	5	n/a	GND	Open	GND	GND
20	4	n/a	GND	Open	GND	Open
19	3	n/a	GND	Open	Open	GND
18	2	n/a	GND	Open	Open	Open
17	n/a	n/a	Open	GND	GND	GND
16	n/a	n/a	Open	GND	GND	Open
15	n/a	n/a	Open	GND	Open	GND
14	n/a	n/a	Open	GND	Open	Open
13	n/a	n/a	Open	Open	GND	GND

4 Electrical Requirements

12	n/a	n/a	Open	Open	GND	Open
11	n/a	n/a	Open	Open	Open	GND
10	n/a	n/a	Open	Open	Open	Open
9	n/a	n/a	Pulled	GND	GND	GND
8	n/a	n/a	Pulled	GND	GND	Open
7	n/a	n/a	Pulled	GND	Open	GND
6	n/a	n/a	Pulled	GND	Open	Open
5	n/a	n/a	Pulled	Open	GND	GND
4	n/a	n/a	Pulled	Open	GND	Open
3	n/a	n/a	Pulled	Open	Open	GND
2	n/a	n/a	Pulled	Open	Open	Open
1 (system slot)	1 (system slot)	1 (system slot)	-	-	-	-

Comment: A 25-slot system is the maximum supported by this specification.

4.2 3U Hybrid System Geographical Addressing

It is possible to build a hybrid system with a CompactPCI® PlusIO system card on the one side and up to four CPCI-S.0 peripheral cards on the other side. The physical slot number and its physical slot address defined by GA[3:0] are compliant to chapter 4.1.2.

Figure 18 **3U Hybrid System**

